

()	()
021-38676820	021-38677388
wangcong@gtjas.com	zhangtianwen@gtjas.com
S0880517010002	S0880118090094

4y

6 SiC

SiC GaN

2020.11.09

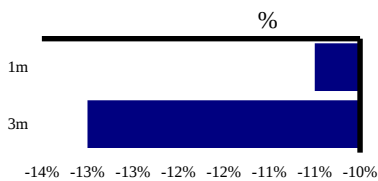
(688396)

87.41

81.07

50.20

www.crmicro.com



52

32.38-63.51

61,039

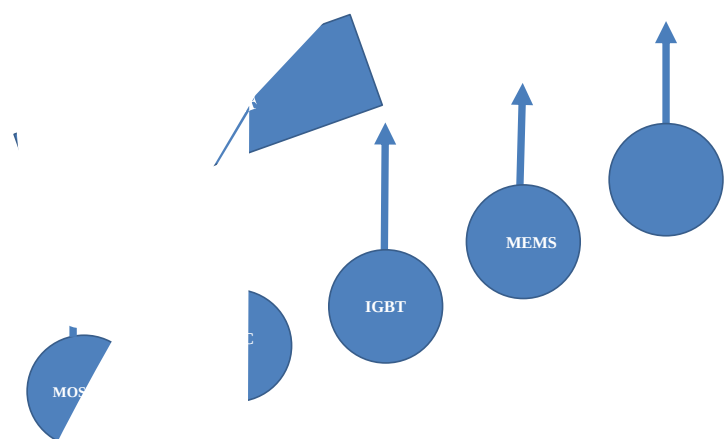
	2018A	2019A	2020E	2021E	2022E
	6,271	5,743	6,719	8,197	10,083
	4,690	4,431	4,752	5,574	6,639
	85	66	77	94	116
	126	112	131	172	219
	374	377	336	410	504
EBIT	546	274	926	1,209	1,646
	0	0	0	0	0
	11	0	0	0	0
	0	31	47	-52	-78
	586	478	1,120	1,564	2,106
	53	-6	116	160	215
	108	112	104	144	193
	429	401	940	1,299	1,738
于					
事	1,538	2,438	7,500	8,639	10,176
于	27	44	44	44	44
	0	82	82	82	82
于可	3,898	3,816	3,806	3,796	3,746
于	571	557	557	557	557
于可	9,992	10,095	15,600	17,446	19,834
	4,654	1,979	2,127	2,480	2,936
	318	1,726	1,726	1,726	1,726
未	5,020	6,391	11,748	13,241	15,173
(IC)	7,471	7,897	13,254	14,747	16,679
NOPLAT	497	277	833	1,088	1,482
承	953	709	510	410	350
	133	-1,192	105	115	144
	-533	-611	-658	-607	-557
	1,050	-816	791	1,006	1,419
	1,482	576	1,497	1,802	2,200
	-575	-41	-658	-607	-557
	-627	-180	4,223	-56	-105
	281	356	5,062	1,139	1,538
	6.7%	-8.4%	17.0%	22.0%	23.0%
EBIT	8150.3%	-49.9%	238.0%	30.6%	36.2%
	511.0%	-6.7%	134.5%	38.3%	33.8%
	25.2%	22.8%	29.3%	32.0%	34.2%
EBIT	8.7%	4.8%	13.8%	14.7%	16.3%
	6.8%	7.0%	14.0%	15.9%	17.2%
于 (ROE)	10.4%	7.4%	8.8%	10.8%	12.6%
于 (ROA)	5.4%	5.1%	6.7%	8.3%	9.7%
(ROIC)	6.7%	3.5%	6.3%	7.4%	8.9%
	91.9	86.9	86.9	86.9	86.9
	35.0	51.8	51.8	51.8	51.8
于	581.6	641.6	847.5	776.8	718.0
	3.5	1.4	1.6	1.4	1.3
/	8.5%	10.6%	9.8%	7.4%	5.5%
于	49.8%	36.7%	24.7%	24.1%	23.5%
	99.1%	58.0%	32.8%	31.8%	30.7%
PE	142.14	152.31	64.95	46.97	35.11
PB	11.69	8.44	5.72	5.08	4.44
EV/EBITDA	0.61		36.97	33.61	26.49
P/S	6.64	7.25	8.72	7.45	6.05
	0.0%	0.1%	0.3%	0.4%	0.6%

1.			4
2.			. 5
2.1.	SiC GaN		.. 5
2.2.	SiC		8
2.3.	GaN		12
3.	6 SiC		
			15
3.1.	6 SiC GaN		15
3.2.	SiC		17
4.			19
5.			19
6.			20

1.

MOSFET IGBT

1



1

2

9 25

(688396)

4

IGBT

GaN **SiC** **SiC MOSFET**

2.

Material	Market Share (%)
SiC	500
GaN	5G

2.1. SiC GaN

/
 /
 (GaAs) (InP) (GaN) (SiC)
 /
 (Ge) (Si) (Se) (B)
 50

60

(InSb)

(GaN)

(SiC)

(GaAs)
(CdS)

20

(InP)

90

(GaAs)

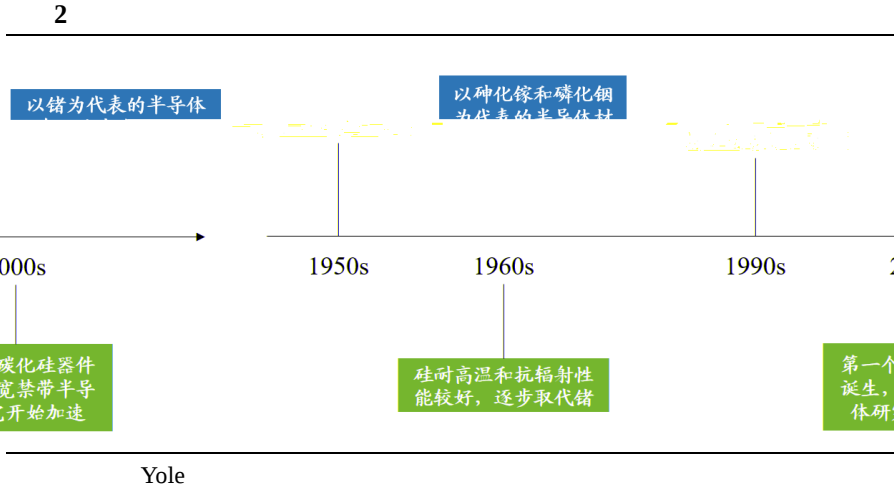
(InP)

1

2

(LED)

(LD)



SiC

GaN

(Eg)

2.3

(eV)

3

SiC

GaN

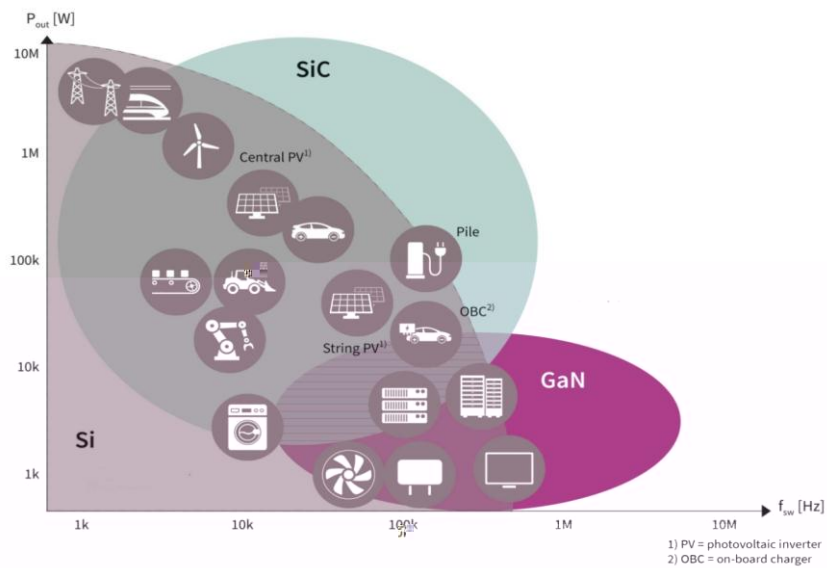
(SiC) (GaN)

1:

	Si	GaAs	GaN
eV	1.1	1.4	3.4
10^{-7}cm/s	1.0	2.1	2.7
W/c K	1.3	0.6	2.0
M/cm	0.3	0.4	5.0
$\text{cm}^2/\text{V s}$	1350	8500	900

/

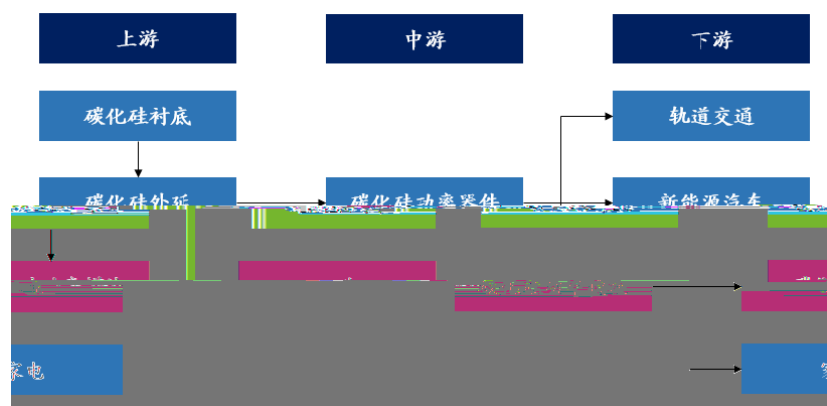
4



2.2. SiC

4H SiC(4H-SiC)

5 SiC



1 /

2010

Cree

6

2015

2015

Cree

II-VI

8

6

2030

6

SiC

40

Yole

2017

4

10

6

1.5

2020

4

10

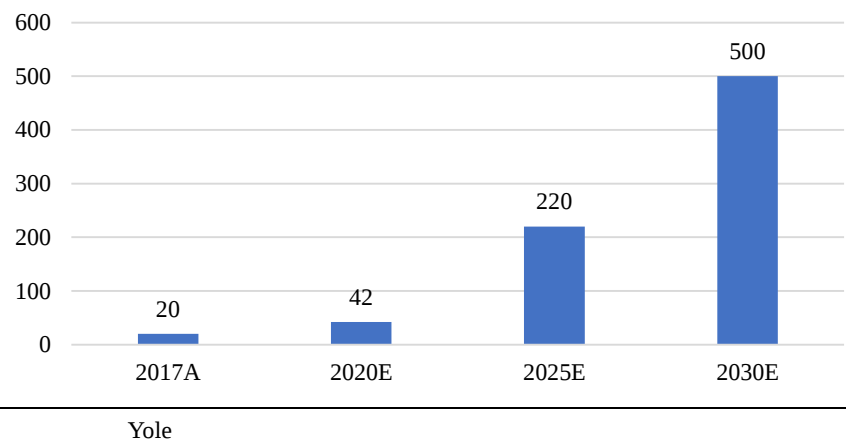
6

8

2020 TD[2i826 0 0 Tm EMC /P /MCID 84/Lang(en-US)>BDC

SiC	SBD	
	PiN	PiN
	JBS	
	PiN	MPS
SiC	MOSFET	
	BJT	
	JFET	
	IGBT	

21 SiC JBS
 () MOSFET 2001
 (Infineon)
 Cree



1

2

3

4

99 %

50 %

5
2001 600 V

SiC MOSFET JBS
SiC MOSFET
SiC JBS

7 4 SiC
SiC

5G 2020 5G
SiC

SiC

10 SiC

11 SiC



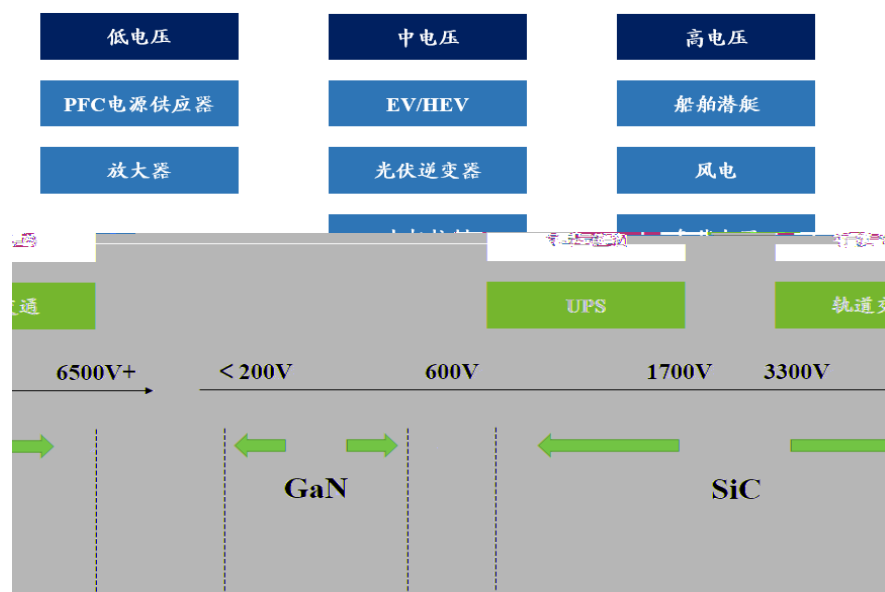
行业	新基建投资金额
5G ✓	2020年投资规模近3000亿元
特高压	2020年投资规模超600亿元
轨道交通	2020年投资规模在5000亿元左右
充电桩 ✓	2020年投资规模约100亿元
数据中心 ✓	2020年投资规模约1000亿元
人工智能	2020年投资规模约350亿元
投资规模或达百亿级别	工业互联网 2020年

SiC

2.3. GaN

GaN 600V GaN 1700
GaN GaN
Si 600V SiC 300V~600V GaN
0~300V

600V



GaN

GaN

GaN

Si

SiC

GaN-on-Si

GaN-on-SiC

GaN-on-SiC

GaN

SiC

GaN

SiC

GaN

GaN-on-Si

GaN-on-SiC

Macom

GaN-on-Si

GaN-on-SiC

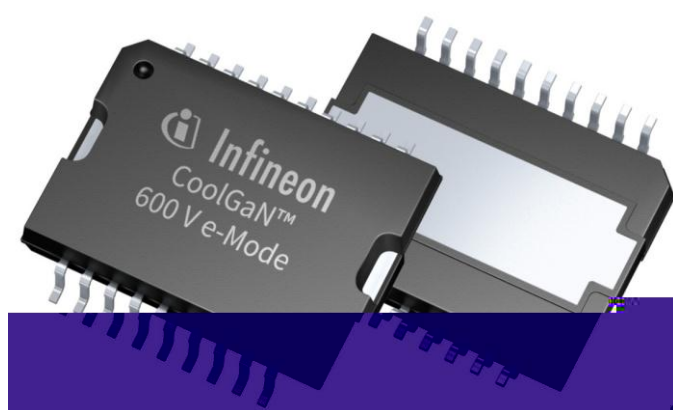
on-Si

GaN-

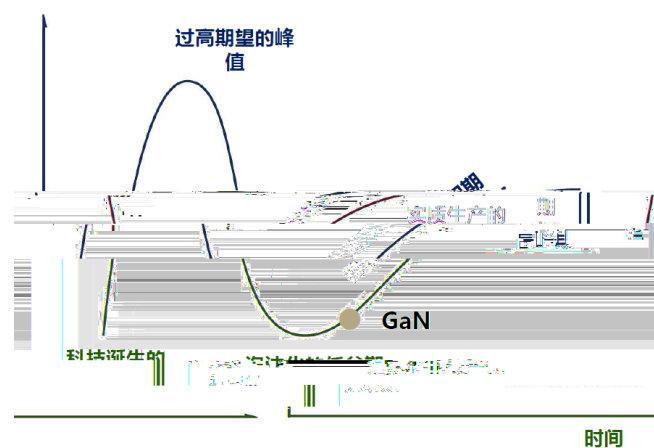
SiC

GaN-on-Si

CoolGaN



GaN



15 GaN-on-Si

	LDMOS	MACOM GaN	GaN on SiC	Benefits
Power Amp Efficiency ">25Hz"		>10% Improvement	Improvement	Lower Operating Expense
Higher Frequency Bands	1.8 GHz	Up to >3.8 GHz	Up to >3.8 GHz	New Spectrum Deployments
Wider Bandwidths	100 MHz	200 MHz	200 MHz	Higher Capacity per Basestation
Power Density	1-1.5 W/mm	4-6 W/mm	4-8 W/mm	Smaller Antenna, Lower CapEx
Linearity	DPD Friendly	DPD Friendly	Charge Trapping	Higher Order Modulation Scheme
Supply Chain	8"	Up to 8"	4" → 6"	Capacity and Surge Capability
Cost	Silicon	Silicon	SiC	LDMOS Like Cost Structure

GaN											
GaN			(SBD)				(FET)				
(PA)			(LNA)				GaN				
			GaN				GaN				
2018							GaN				
2020			CES				66				
18W	30W	65W	100W								
2020	2	13	10								
65W											
Yole			2017				GaN				
1000				2023				4.3			
2023	CAGR	87%							2017-		

3. 6 SiC

SiC 2020 7 SiC
6 SiC
SiC JBS GaN
SiC

3.1. 6 SiC GaN

2020

1 2020 2

2020 2

SiC MOSFET 650V GaN IDM SiC JBS
2 2020 7
7 SiC 6 SiC
4 1200V 650V SiC SiC 2020 7
6 SiC GaN

3 2020 8

SiC JBS

2020

GaN

6

650V

1200V SiC JBS

SiC JBS

650V

MOCVD

4 2020 9

6

SiC

2020 8

6

SiC

2020 9

1000

SiC

18	SiC	SiC				
1200V					650V	
电流等级 (A)	T0220 R2L	T0247 Dual Die	T0247 R2L	DPAK R2L	电流等级 (A)	T0220 R2L
2A	CRXI02D120G1			GRXL02D120G1	4A	CRXI04D065G1
	CRXL05D120G1	6A	CRXI06D065G1	5A	CRXI05D120G1	
RX115D120G1		CRXU20D120G1		10A	CRXI10D065G1	15A
	CRXI16D065G1	30A	CRXQ30D120G1			16A
	40A		CRXQ40D120G1			

SiC

SiC GaN

IDM

3.2.

SiC

3.24%

SiC

1

2011

2012

3

4

SiC

2014

6

SiC

2011

3

Aixtron

2012 3 9

3

4

2014 4

6

6

2

32.64%

JIANHUI ZHAO

1988

7.46%

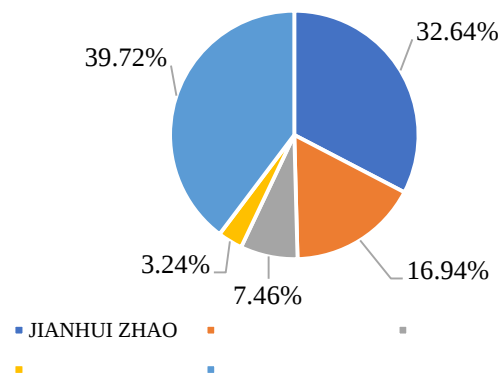
16.94%
5.14%
3.24%

19



20

3.24%



3

2020 10 10
41

2019 12

2013 9

3:

2020 10 10

	CN201911405142.5	CN111167780A	2019/12/30
	CN201911400025.X	CN111088522A	2019/12/30
T	CN201911400028.3	CN111058091A	2019/12/30
	CN201911400042.3	CN111101196A	2019/12/30
	CN201721375888.2	CN207439989U	2017/10/24
	CN201711000158.9	CN107829135A	2017/10/24
	CN201721078400.X	CN207130366U	2017/08/25
	CN201721073570.9	CN207130365U	2017/08/25
	CN201610377959.6	CN106087039A	2016/05/31
	CN201610351566.8	CN106057694B	2016/05/24

SiC

IDM

IGBT

15%

PB 2021 PB 6.98 2021
 8.03 PB 87.41
PS 2021 PS 11.55 2021 13.28
 PS 89.55

87.41

5 2020 11 5

			P/S				PB		
			2021E)	2020E	2021E	2022E	2020E	2021E	2022E
300623.SZ		41.58	16.86	4.81	5.26	5.83	8.64	7.90	7.13
300373.SZ		41.69	6.23	6.04	6.89	7.93	6.90	6.05	5.26
			11.55	-			7.77	6.98	6.19
688396.SH		49.92	7.45	8.78	9.89	11.32	5.69	5.05	4.41

wind

wind

6.

且

且

强

可

安

京
强 安

京

取

京

安

取

京

强

取

取

取 取

强

且

更 取

可

安

安

且

且

公

公

取

且
于咨

更

未
取

未事
取

取

取

取

司

未京

取

公

士

事

安

且

公

司

安

公

公

且

公

且

且

且